

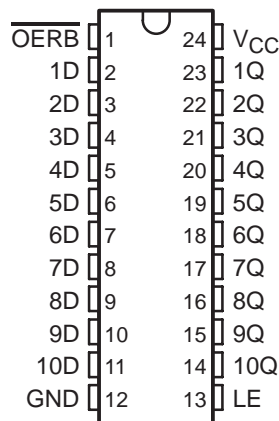
SN74ALS994

10-BIT D-TYPE TRANSPARENT READ-BACK LATCH

SDAS237A – OCTOBER 1984 – REVISED JANUARY 1995

- 3-State I/O-Type Read-Back Inputs
- Bus-Structured Pinout
- True Logic Outputs
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

DW OR NT PACKAGE
(TOP VIEW)



description

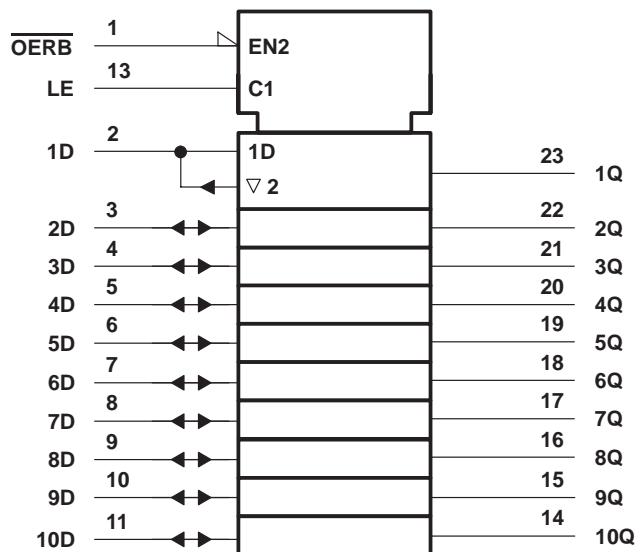
This 10-bit latch is designed specifically for storing the contents of the input data bus and providing the capability of reading back the stored data onto the input data bus.

The ten latches are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs.

Read back is provided through the output-enable ($\overline{\text{OERB}}$) input. When $\overline{\text{OERB}}$ is taken low, the data present at the output of the data latches passes back onto the input data bus. When $\overline{\text{OERB}}$ is taken high, the output of the data latches is isolated from the D inputs. $\overline{\text{OERB}}$ does not affect the internal operation of the latches; however, precautions should be taken to avoid a bus conflict.

The SN74ALS994 is characterized for operation from 0°C to 70°C.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
I_{OH}	High-level output current	Q		-2.6	mA
		D		-0.4	
I_{OL}	Low-level output current	Q		24	mA
		D		8	
t_w	Pulse duration, LE high	10			ns
t_{su}	Setup time	Data before LE↓	10		ns
		Data before \overline{OERB} ↓†	10		
t_h	Hold time, data after LE↓	5			ns
T_A	Operating free-air temperature	0		70	°C

† This setup time ensures that the read-back circuit will not create a conflict on the input data bus.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP‡	MAX	UNIT
V_{IK}		$V_{CC} = 4.5\text{ V}$,	$I_I = -18\text{ mA}$			-1.2	V
V_{OH}	All outputs	$V_{CC} = 4.5\text{ V to }5.5\text{ V}$,	$I_{OH} = -0.4\text{ mA}$	$V_{CC} - 2$			V
	Q	$V_{CC} = 4.5\text{ V}$,	$I_{OH} = -2.6\text{ mA}$	2.4	3.2		
V_{OL}	D	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 4\text{ mA}$	0.25	0.4	V	
			$I_{OL} = 8\text{ mA}$	0.35	0.5		
	Q	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 12\text{ mA}$	0.25	0.4		
			$I_{OL} = 24\text{ mA}$	0.35	0.5		
I_I	\overline{OERB} , LE	$V_{CC} = 5.5\text{ V}$	$V_I = 7\text{ V}$		0.1	mA	
	D inputs		$V_I = 5.5\text{ V}$		0.1		
I_{IH}	\overline{OERB} , LE	$V_{CC} = 5.5\text{ V}$,	$V_I = 2.7\text{ V}$		20	μA	
	D inputs§				20		
I_{IL}	\overline{OERB} , LE	$V_{CC} = 5.5\text{ V}$,	$V_I = 0.4\text{ V}$		-0.1	mA	
	D inputs§				-0.1		
I_{O}^{\parallel}		$V_{CC} = 5.5\text{ V}$,	$V_O = 2.25\text{ V}$	-30		-112	mA
I_{CC}		$V_{CC} = 5.5\text{ V}$,	\overline{OERB} high	Q outputs high	30	50	mA
				Q outputs low	52	82	

‡ All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

§ For I/O ports (Q_A thru Q_H), the parameters I_{IH} and I_{IL} include the off-state output current.

¶ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .



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switching characteristics (see Figure 1)

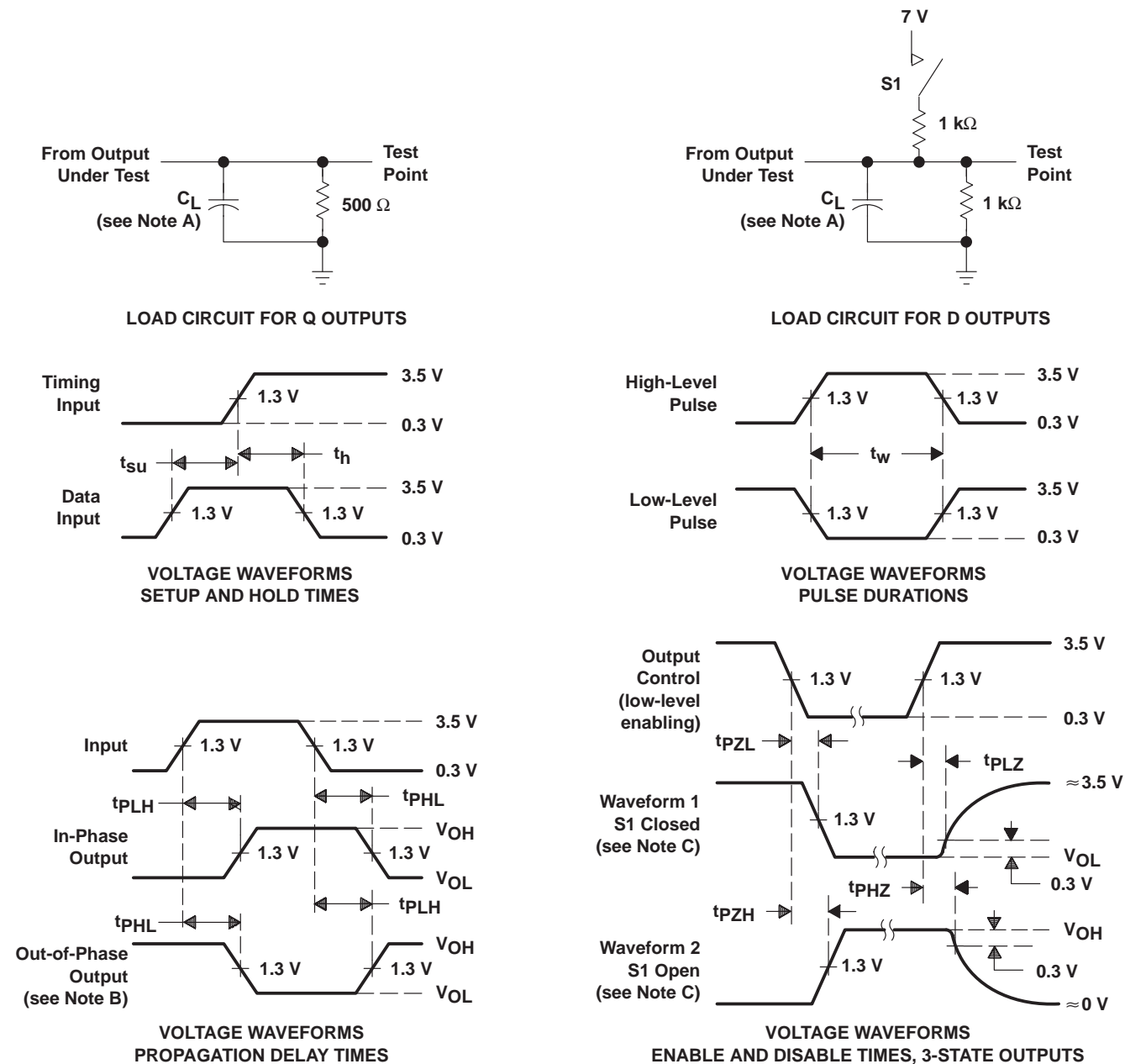
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, T _A = MIN to MAX†		UNIT
			MIN	MAX	
t _{PLH}	D	Q	3	14	ns
t _{PHL}			4	18	
t _{PLH}	LE	Q	6	21	ns
t _{PHL}			8	27	
t _{en} ‡	$\overline{\text{OERB}}$	D	4	21	ns
t _{dis} §			2	16	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ t_{en} = t_{PZH} or t_{PZL}

§ t_{dis} = t_{PHZ} or t_{PLZ}

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. When measuring propagation delay times of 3-state outputs, switch S1 is open.
 C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.

Figure 1. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ALS994DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS994DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS994DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS994NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS994NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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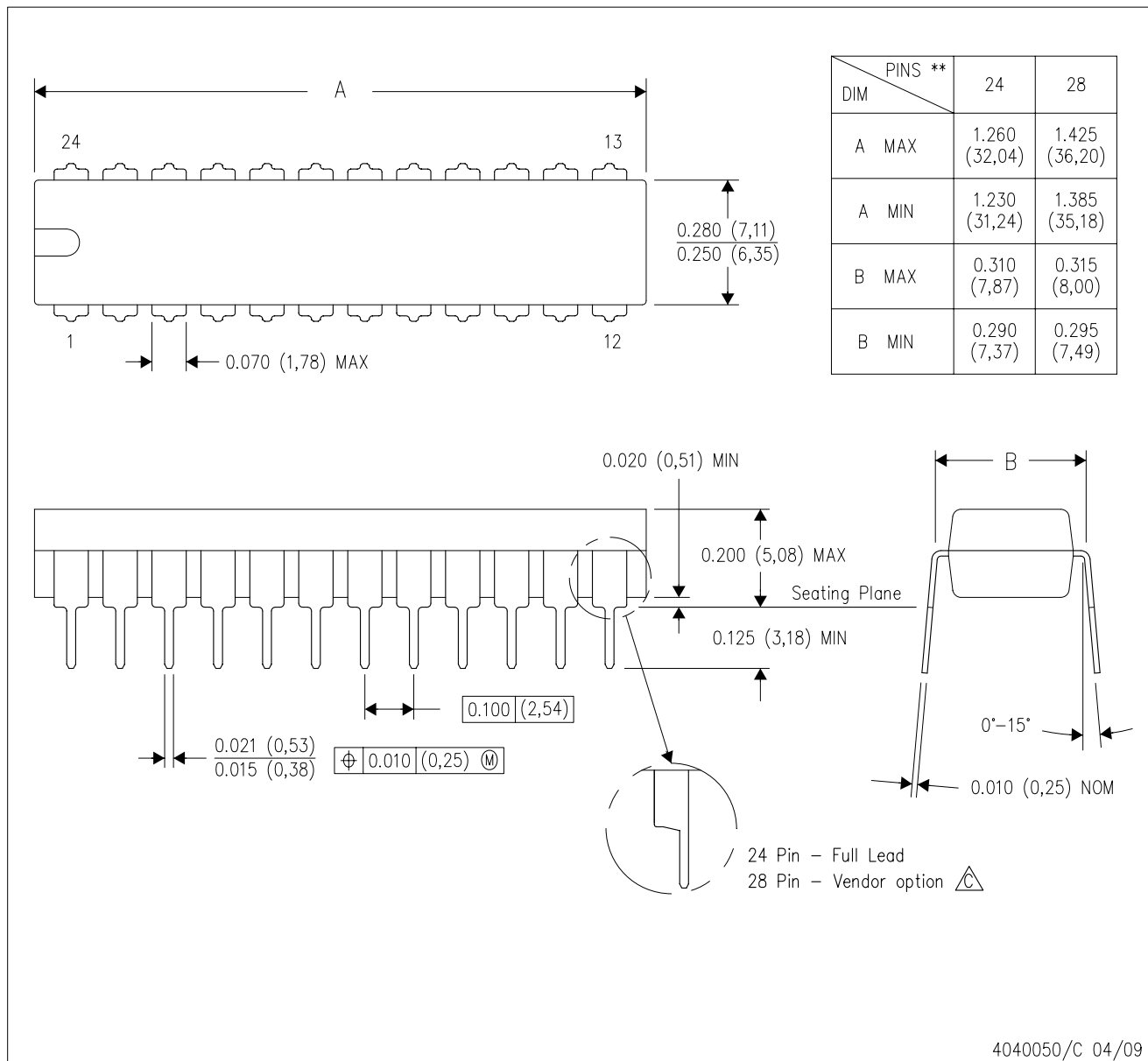
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MECHANICAL DATA

NT (R-PDIP-T**)


PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

 The 28 pin end lead shoulder width is a vendor option, either half or full width.

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